

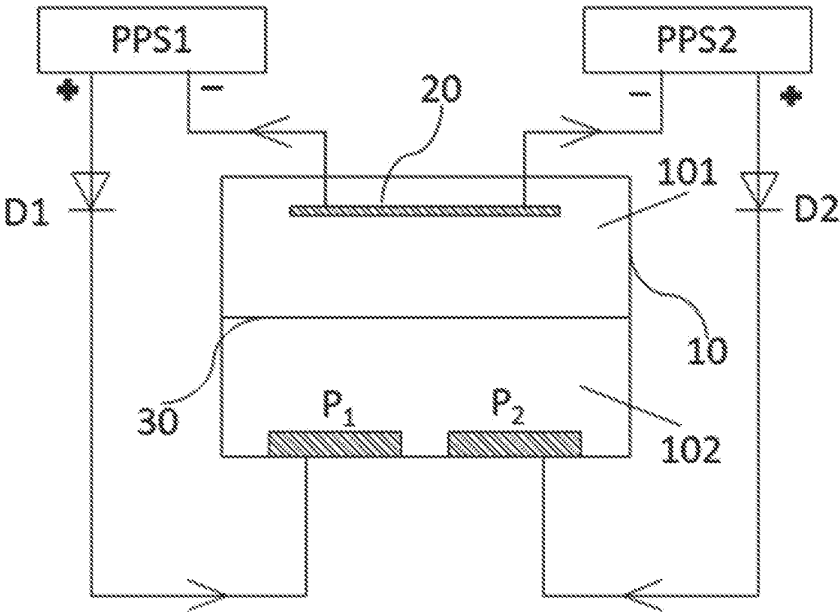


图 1

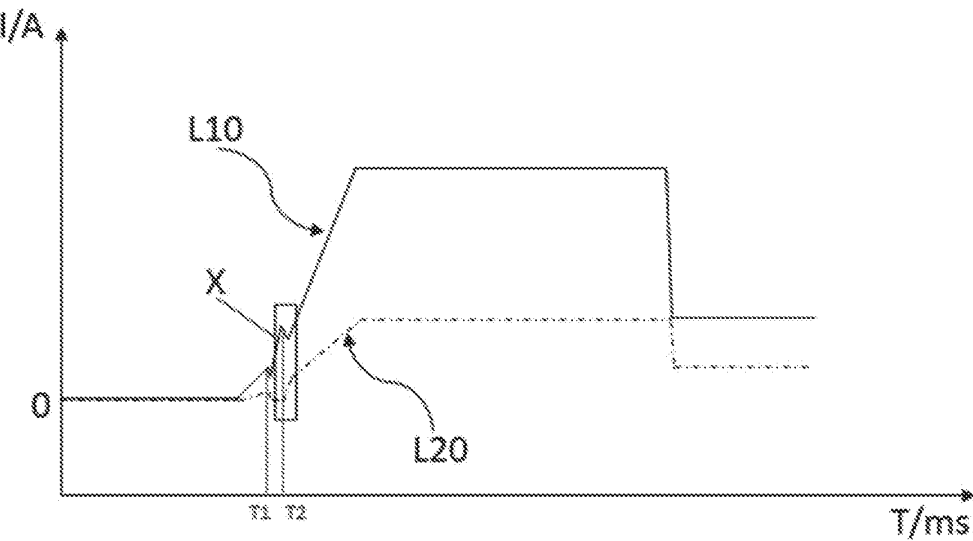


图 2

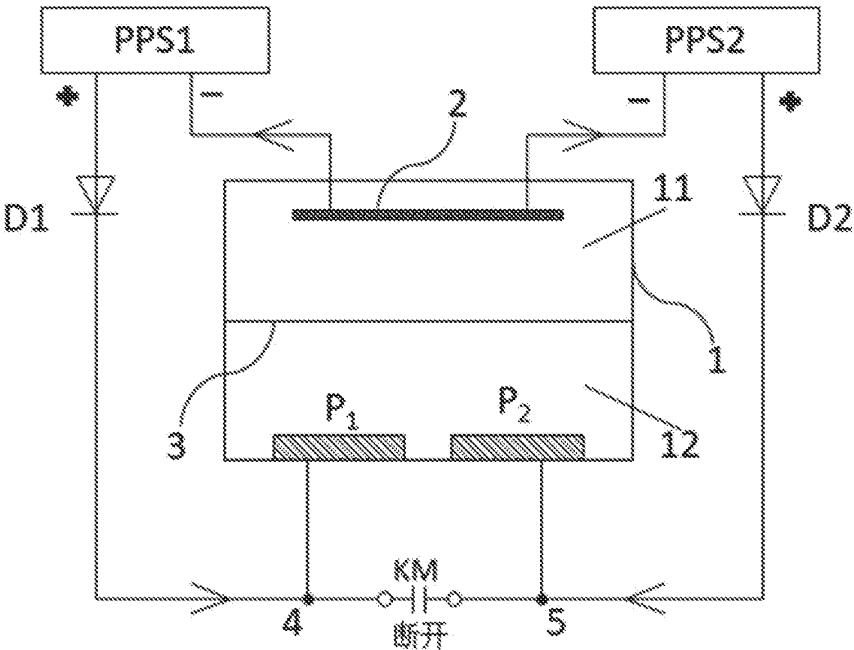


图 3a

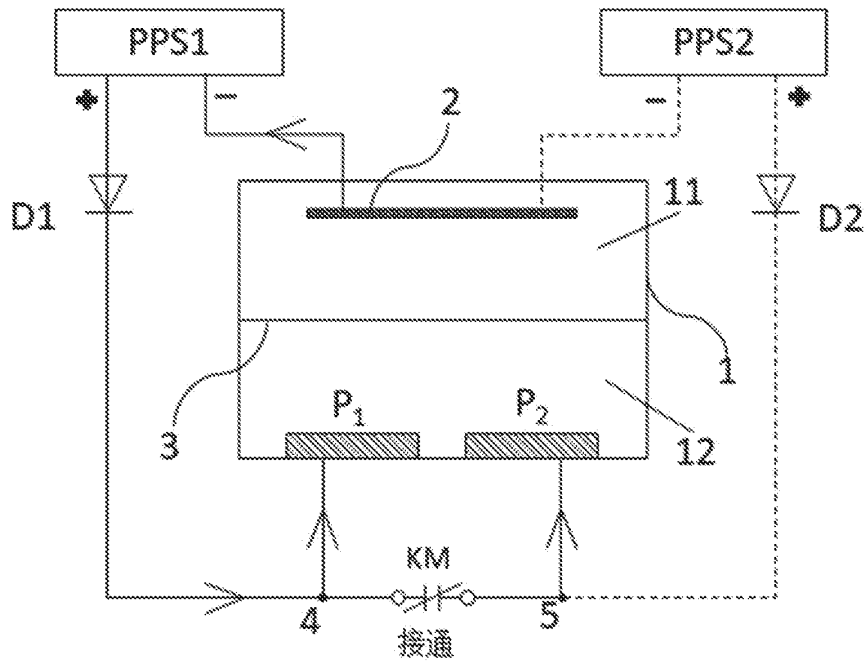


图 3b

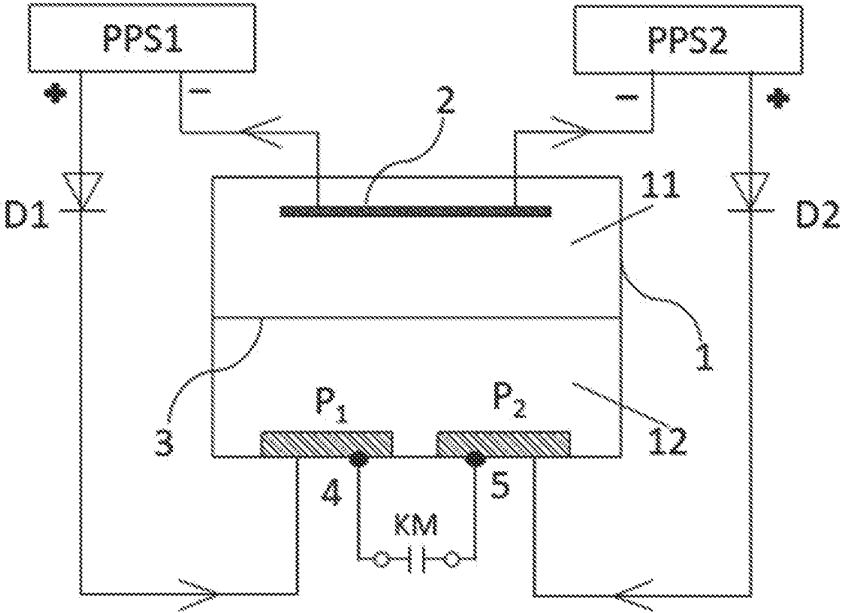


图 3c

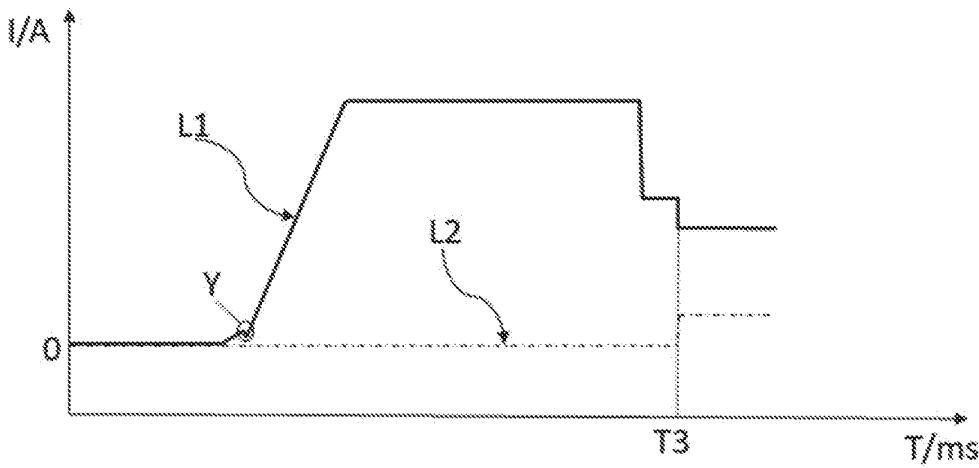


图 4

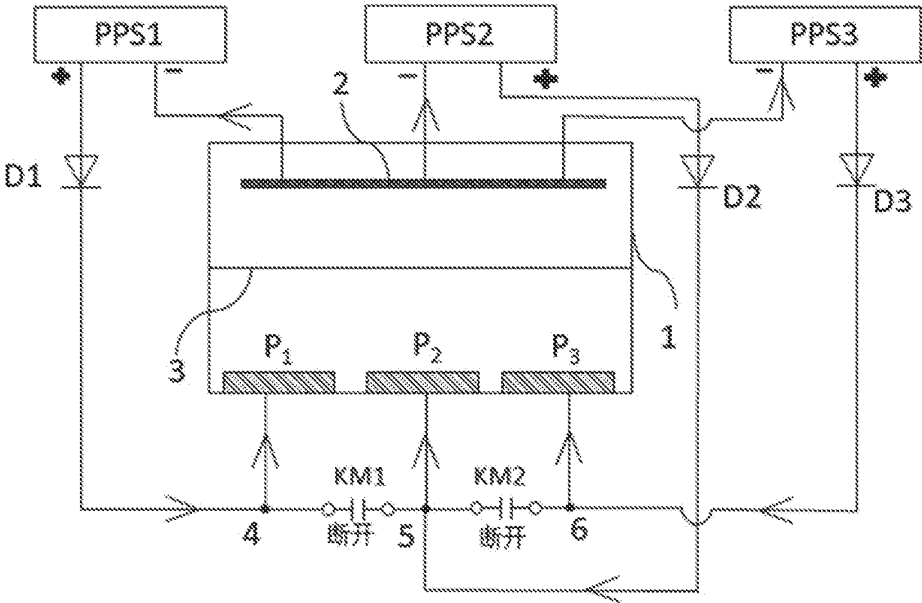
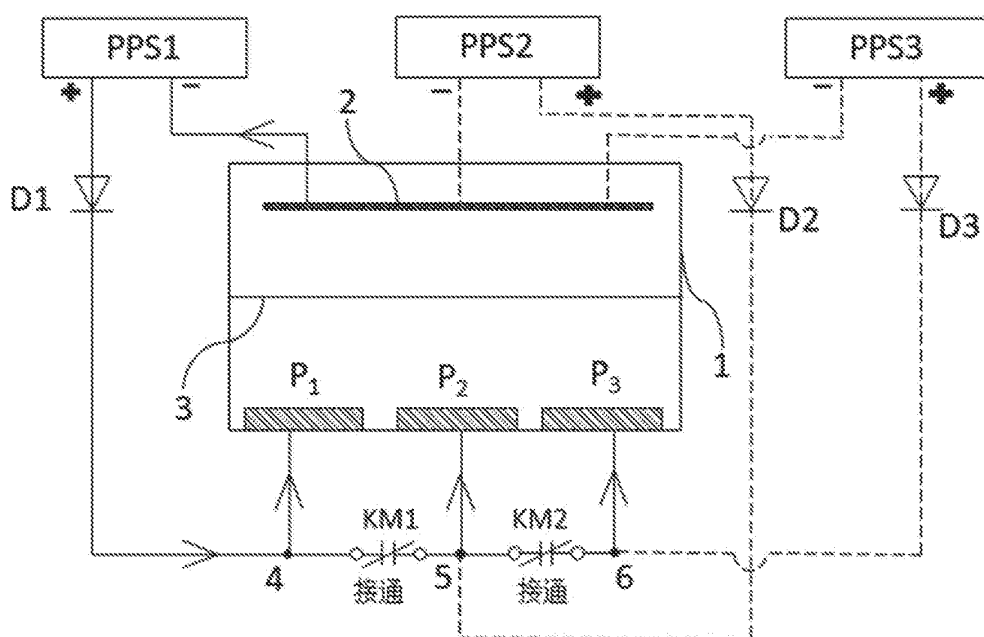


图 5a



5b

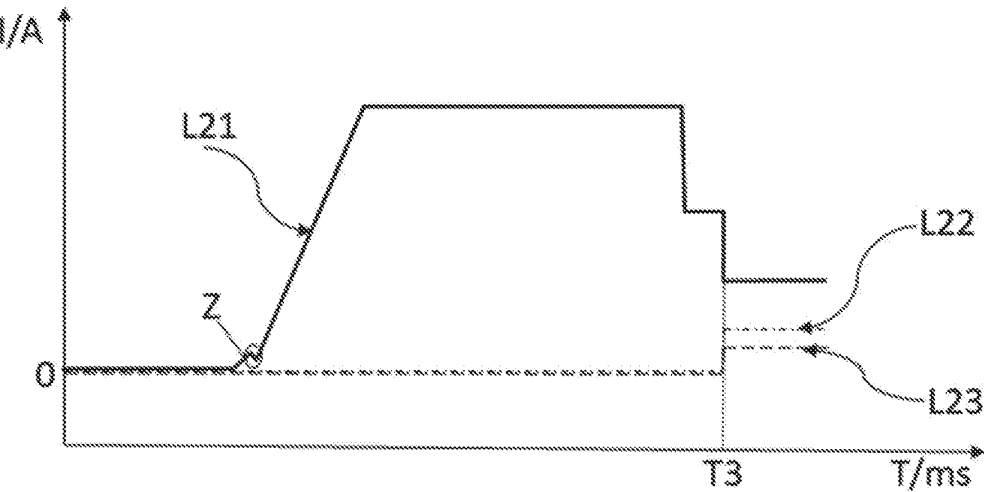


图 6

在基板的入水阶段，接通接触器KM，启动第一电源PPS1，关闭第二电源PPS2，第一阳极P1和第二阳极P2连接至第一电源PPS1并由第一电源PPS1控制；

在基板的电镀工艺阶段，断开接触器KM，启动第二电源PPS2，第一阳极P1由第一电源PPS1控制，第二阳极P2由第二电源PPS2控制。

图 7

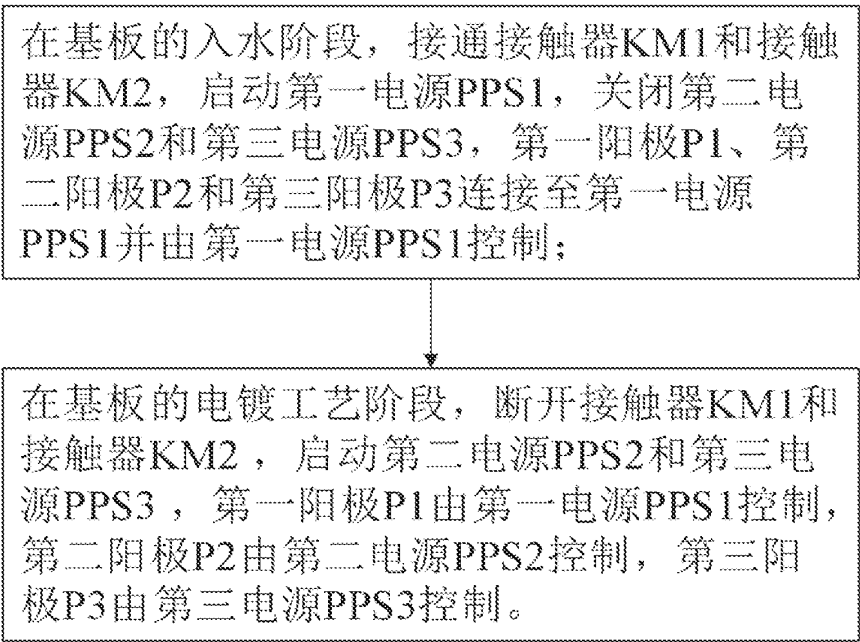


图 8